



# Welcome to Hot Chips 33! Organizing Committee Ian Bratt & Cliff Young

Conference Sponsor: IEEE Technical Committee  
on Microprocessors and Microcomputers

*Thank You!*






# Slack Overview

- Sign-up info sent with your credentials
- Interact with speakers
- #a1-announcements
- #a2-help
- #a3-general
- “c” for conference talks
- “k” for keynotes
- “p” for posters
- “s” for sponsors
- “t” for tutorials

## During talks:

- Ask a question if you haven’t seen it asked
- “Upvote” existing questions with thumbs up emoji  3
- There will be an applause thread at the end of each talk where you can thank the speaker





# Behind the Scenes

## Volunteer Run Conference

- Steering Committee
- Operating Committee
- Program Committee



Chair	Ian Bratt	ARM
Vice Chair	Cliff Young	Google
Advertising	Don Draper	ProPrincipia
Web/IT	Kevin Broch	<a href="#">Rivos Inc.</a>
Katherine Bennett		
Location Services	John Sell	<a href="#">Intel</a>
Allen Baum · Esperanto Technologies		
Finance	Lily Jow	
Production	Lance Hammond	
Keith Diefendorff		
Publications	Stefan Rusu	TSMC
Registration	Charles Neuhauser	Neuhauser Associates, Inc
Sponsorship	Amr Zaky	
Volunteers	Gabriel Southern	<a href="#">Qualcomm</a>
Rohan Ganpati Cadence		
Marketing	Gary Brown	Intel
Aishwarya Nagarajan Google		
Press	Ralph Wittig	Xilinx

# **Welcome to the** **Hot Chips 33 Program**

Guri Sohi (University of Wisconsin)  
Alisa Scherer

# Hot Chips 33 Program Committee



Krste Asanovic, UC Berkeley/SiFive

Forest Baskett, NEA

Ron Diamant, Amazon

Pradeep Dubey, Intel

Yoshio Masubuchi, Toshiba

Vartika Singh, NVIDIA

Natalia Vassilieva, Cerebras

David Kanter, Real World Tech

Derek Chiou, Microsoft

Kunle Olukotun, Stanford/SambaNova

Guri Sohi, U. Wisconsin (co-chair)

Debjit das Sarma, Tesla

Tayo Oguntebi, Google

Alan Smith, UC Berkeley

Fred Weber

Ralph Wittig, Xilinx

Rob Aitken, ARM

Jason Lowe-Power, UC Davis

Yuan Xie, UCSB/Alibaba

Gabriel Loh, AMD

Nam Sung Kim, U. Illinois

Alisa Scherer (co-chair)



# Tutorials

- ML Performance and Challenges
  - NVIDIA, Google
  - Intel, Graphcore
  - Facebook
  - Amazon, Microsoft
- Advanced Packaging
  - Intel
  - AMD
  - TSMC
  - TechSearch International, Inc

# Keynotes



## **Does Artificial Intelligence Require Artificial Architects?**

Aart de Geus

CEO, Synopsys

Monday 12.30pm (PDT)



## **Skydio Autonomy Engine: Enabling the Next Generation of Autonomous Flight**

Abraham Bachrach

CTO, Skydio

Monday 4.00pm (PDT)



## **Architectural challenges: AI chips, Decision Support and High Performance Computing**

Dimitri Kusnezov

Deputy Undersecretary  
for AI and Technology

Tuesday 10.00am (PDT)



# Program Statistics and Sessions

**85 abstract submissions**  
**27 accepted talks**

## **Monday**

CPU's

Chips from Academia

Infrastructure and Data  
Processors

Enabling chips for Automotive,  
5G, and High-bandwidth Memory

## **Tuesday**

ML Inference in the Cloud

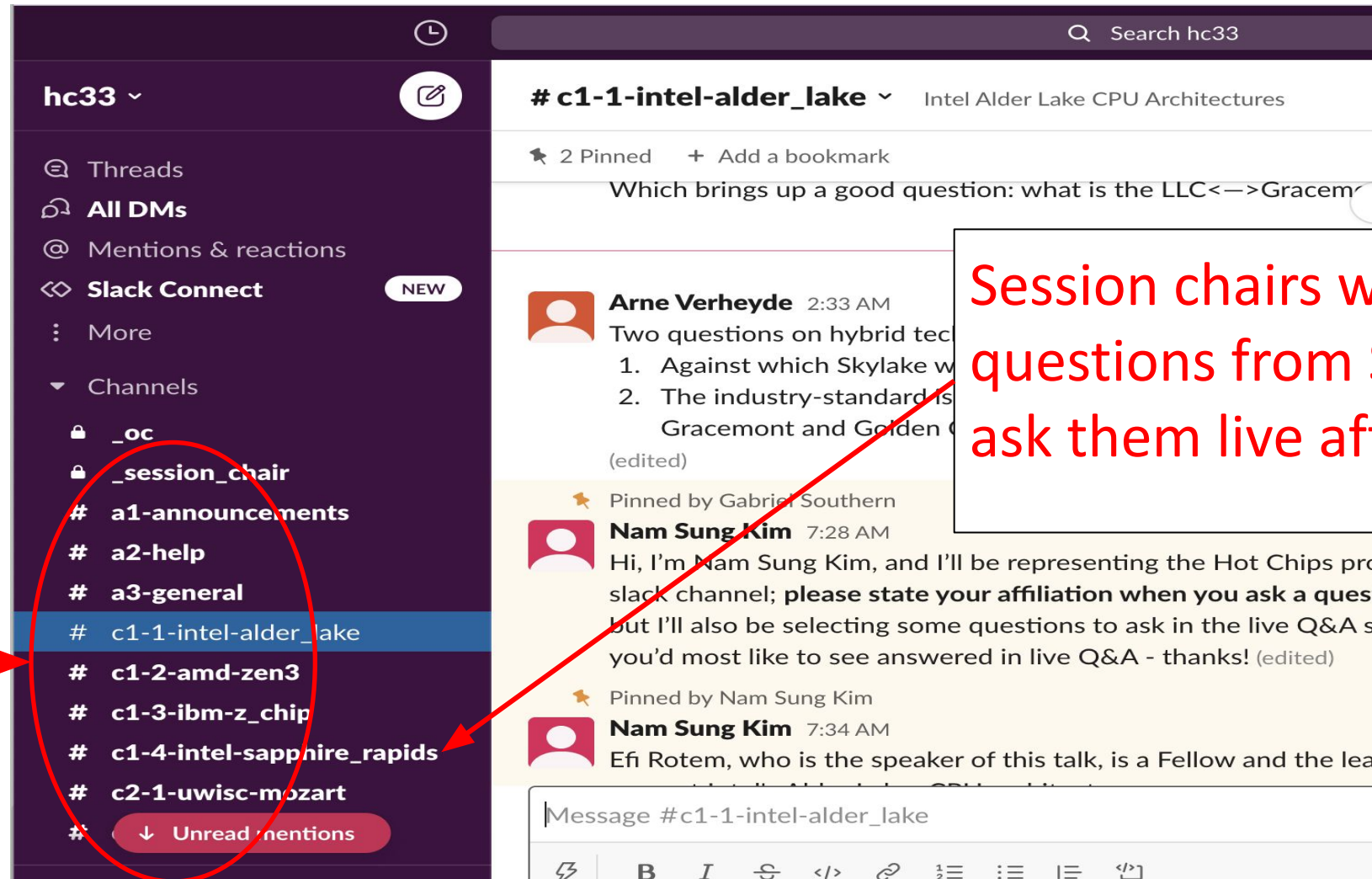
ML Training and Computation Platforms

Graphics and Videos Processors

New Technologies: sensors, quantum  
computing, and AR contact lenses

# Q&A Process Through Slack

Each talk has  
a dedicated  
slack channel





Session chairs will pick  
questions from Slack and  
ask them live after each talk



# Posters

Hot Chips 33 selected 18 outstanding posters

Each poster will be staffed on a schedule determined by the presenter

- Visit them on the <https://hc33.hotchips.org/> **Program** tab
  - Poster links are at the bottom of the page
- Slack Channels for interaction with presenters 
- Links to the poster pdfs 



Enjoy Hot Chips!